

**Designer's Data Sheet**  
**Power Field Effect Transistor**  
**P-Channel Enhancement-Mode**  
**Silicon Gate**

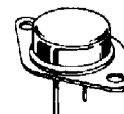
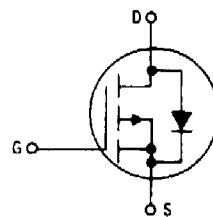
This TMOS Power FET is designed for medium voltage, high speed power switching applications such as switching regulators, converters, solenoid and relay drivers.

- Silicon Gate for Fast Switching Speeds — Switching Times Specified at 100°C
- Designer's Data —  $I_{DSS}$ ,  $V_{DS(on)}$ ,  $V_{GS(th)}$  and SOA Specified at Elevated Temperature
- Rugged — SOA is Power Dissipation Limited
- Source-to-Drain Diode Characterized for Use With Inductive Loads



**MTM20P10**

TMOS POWER FET  
 20 AMPERES  
 $R_{DS(on)} = 0.15 \text{ OHM}$   
 100 VOLTS



TO-204AA

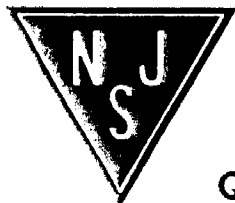
**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	100	Vdc
Drain-Gate Voltage ( $R_{GS} = 1 \text{ M}\Omega$ )	$V_{DGR}$	100	Vdc
Gate-Source Voltage Continuous	$V_{GS}$	$\pm 20$	Vdc
Non-repetitive ( $t_p \leq 50 \mu\text{s}$ )	$V_{GSM}$	$\pm 40$	Vpk
Drain Current Continuous	$I_D$	20	Adc
Pulsed	$I_{DM}$	80	
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	125 1	Watts W/°C
Operating and Storage Temperature Range	$T_J, T_{stg}$	-65 to 150	°C

**THERMAL CHARACTERISTICS**

Thermal Resistance Junction to Case	$R_{\theta JC}$	1	°C/W
Junction to Ambient	$R_{\theta JA}$	30	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	$T_L$	300	°C

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**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit	
<b>OFF CHARACTERISTICS</b>					
Drain-Source Breakdown Voltage ( $V_{GS} = 0, I_D = 0.25 \text{ mA}$ )	$V_{(BR)DSS}$	100	—	Vdc	
Zero Gate Voltage Drain Current ( $V_{DS} = \text{Rated } V_{DSS}, V_{GS} = 0$ ) ( $V_{DS} = \text{Rated } V_{DSS}, V_{GS} = 0, T_J = 125^\circ\text{C}$ )	$I_{DSS}$	—	10 100	$\mu\text{Adc}$	
Gate-Body Leakage Current, Forward ( $V_{GSF} = 20 \text{ Vdc}, V_{DS} = 0$ )	$I_{GSSF}$	—	100	nAdc	
Gate-Body Leakage Current, Reverse ( $V_{GSR} = 20 \text{ Vdc}, V_{DS} = 0$ )	$I_{GSSR}$	—	100	nAdc	
<b>ON CHARACTERISTICS*</b>					
Gate Threshold Voltage ( $V_{DS} = V_{GS}, I_D = 1 \text{ mA}$ ) $T_J = 100^\circ\text{C}$	$V_{GS(th)}$	2 1.5	4.5 4	Vdc	
Static Drain-Source On-Resistance ( $V_{GS} = 10 \text{ Vdc}, I_D = 10 \text{ Adc}$ )	$R_{DS(on)}$	—	0.15	Ohm	
Drain-Source On-Voltage ( $V_{GS} = 10 \text{ V}$ ) ( $I_D = 20 \text{ Adc}$ ) ( $I_D = 10 \text{ Adc}, T_J = 100^\circ\text{C}$ )	$V_{DS(on)}$	—	3.2 3	Vdc	
Forward Transconductance ( $V_{DS} = 10 \text{ V}, I_D = 10 \text{ A}$ )	$g_{FS}$	5	—	mhos	
<b>DYNAMIC CHARACTERISTICS</b>					
Input Capacitance	( $V_{DS} = 25 \text{ V}, V_{GS} = 0,$ $f = 1 \text{ MHz}$ ) See Figure 10	$C_{iss}$	—	2000	pF
Output Capacitance		$C_{oss}$	—	950	
Reverse Transfer Capacitance		$C_{rss}$	—	400	
<b>SWITCHING CHARACTERISTICS*</b> ( $T_J = 100^\circ\text{C}$ )					
Turn-On Delay Time	( $V_{DD} = 25 \text{ V}, I_D = 0.5 \text{ Rated } I_D$ $R_{gen} = 50 \text{ ohms}$ ) See Figures 12 and 13	$t_{d(on)}$	—	45	ns
Rise Time		$t_r$	—	200	
Turn-Off Delay Time		$t_{d(off)}$	—	150	
Fall Time		$t_f$	—	150	
Total Gate Charge	( $V_{DS} = 0.8 \text{ Rated } V_{DSS},$ $I_D = \text{Rated } I_D, V_{GS} = 10 \text{ V}$ ) See Figure 11	$Q_g$	52 (Typ)	75	nC
Gate-Source Charge		$Q_{gs}$	22 (Typ)	—	
Gate-Drain Charge		$Q_{gd}$	30 (Typ)	—	
<b>SOURCE DRAIN DIODE CHARACTERISTICS*</b>					
Forward On-Voltage	( $I_S = \text{Rated } I_D$ $V_{GS} = 0$ )	$V_{SD}$	2.8 (Typ)	4	Vdc
Forward Turn-On Time		$t_{on}$	100 (Typ)	—	ns
Reverse Recovery Time		$t_{rr}$	350 (Typ)	—	ns

\*Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .